

No
ors: No
Plated Board Edge: No

In1.Cu	copper		0.035 mm
Dielectric 2	core	FR4	1.1 mm
In2.Cu	copper		0.035 mm
Dielectric 3	prepreg	1080	0.14 mm
B.Cu	copper		0.035 mm
B.Mask	Bottom Solder Mask	Not specified	0.01 mm
B.Paste	Bottom Solder Paste		0 mm
B.Silkscreen	Bottom Silk Screen	Not specified	0 mm

